TGP3510PT Thermally Conductive Gap Pad

BENEFITS AND FEATURES

- High thermal performance
- Ultra-soft
- High compressibility
- Excellent gap-filling capability
- Naturally tacky

TYPICAL APPLICATIONS

- EV battery & charging station
- Automotive electronics
- Power devices & modules
- •Telecommunications & network servers

OVERVIEW

Honeywell TGP3510PT Thermally Conductive Gap Pad provides high thermal performance and excellent thermal reliability. The material's putty-like design enables excellent gap-filling capability for applications with large dimensional variances. Special surface reinforcement enables easier handling for operators during high volume assembly. The product is naturally tacky and requires no additional adhesive to mate to heat source and heat sink. Products are available in thicknesses ranging from 0.5mm to 5.0mm with 0.25mm incremental.

STORAGE & USE

Shelf Life 12 months at 0-35°C, <65%RH

Product Name	TGP 3510PT	Test Method
Color	Green	Visual
Thickness (mm)	0.5-5	ASTM D374
Thermal Conductivity (W/m·K)	3.5	ASTM D5470
Thermal Impedance(°C·in²/W) (1mm@10psi) (Typical Value)	0.45	ASTM D5470
Hardness (Shore00)	15	ASTM D2240
Specific Gravity	3.2	ASTM D792
Dielectric Constant@1MHz	6.4	ASTM D150
Volume Resistivity (ohm·cm)	4 x 10 ¹³	ASTM D257
Flammability Rating	V-0	UL94

Honeywell Electronic Materials

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